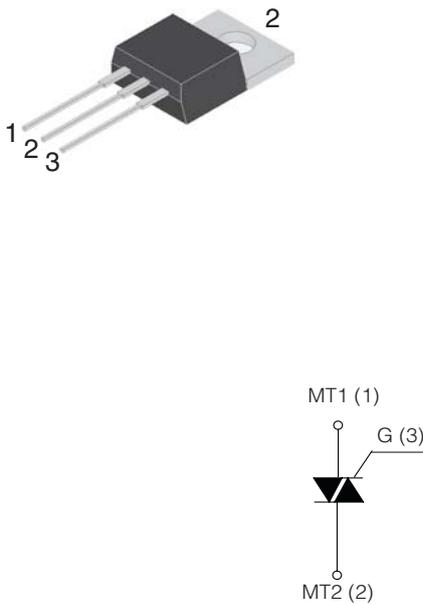


LOGIC LEVEL TRIAC

TO-220AB 	On-State Current 12 Amp	Gate Trigger Current ≤ 10 mA	
	Off-State Voltage 400 V ÷ 800 V		
	FEATURES <ul style="list-style-type: none"> • Glass/passivated die junctions • Medium current Triac • Ideal for automated placement • Low thermal resistance • High surge current capability • Low forward voltage drop • Solder dip 260°C, 10s • Component in accordance to RoHS 2011/65/EU and WEEE 2002/96/EC • Meets MSL level 3, per J-STD-020, LF maximum peak of 260° C 		 RoHS COMPLIANT
	MECHANICAL DATA <ul style="list-style-type: none"> • Case: TO-220AB. Epoxy meets UL 94V-0 flammability rating. • Polarity: As marked on the body. • Terminals: Matte tin plated leads, solderable per MIL-STD-750 Method 2026, J-STD-002 and JESD22-B102. Consumer grade, meets JESD 201 class 1A whisker test. 		
TYPICAL APPLICATIONS Logic level versions are designed to interface directly with low power drivers such as microcontrollers.			

Maximun Ratings and Electrical Characteristics at 25°C

SYMBOL	PARAMETER	CONDITIONS	Value	Unit
$I_{T(RMS)}$	RMS On-state Current (full sine wave)	All Conduction Angle, $T_c = 105\text{ }^\circ\text{C}$	12	A
I_{TSM}	Non-repetitive On-State Current	Full Cycle, 60 Hz ($t = 16.7\text{ ms}$)	125	A
I_{TSM}	Non-repetitive On-State Current	Full Cycle, 50 Hz ($t = 20\text{ ms}$)	120	A
I^2t	Fusing Current	$t_p = 10\text{ ms}$, Half Cycle	72	A^2s
I_{GM}	Peak Gate Current	20 μs max. $T_j = 125\text{ }^\circ\text{C}$	4	A
$P_{G(AV)}$	Average Gate Power Dissipation	$T_j = 125\text{ }^\circ\text{C}$	1	W
di/dt	Critical rate of rise of on-state current	$I_G = 2 \times I_{GT}$, $t_r \leq 100\text{ ns}$ $f = 120\text{ Hz}$, $T_j = 125\text{ }^\circ\text{C}$	50	$A/\mu\text{s}$
T_j	Operating Temperature		(-40 +125)	$^\circ\text{C}$
T_{stg}	Storage Temperature		(-40 +150)	$^\circ\text{C}$
T_{sld}	Soldering Temperature	10s max	260	$^\circ\text{C}$

SYMBOL	PARAMETER	VOLTAGE			Unit
		D	M	N	
V_{DRM}/V_{RRM}	Repetitive Peak Off State Voltage	400	600	800	V

LOGIC LEVEL TRIAC

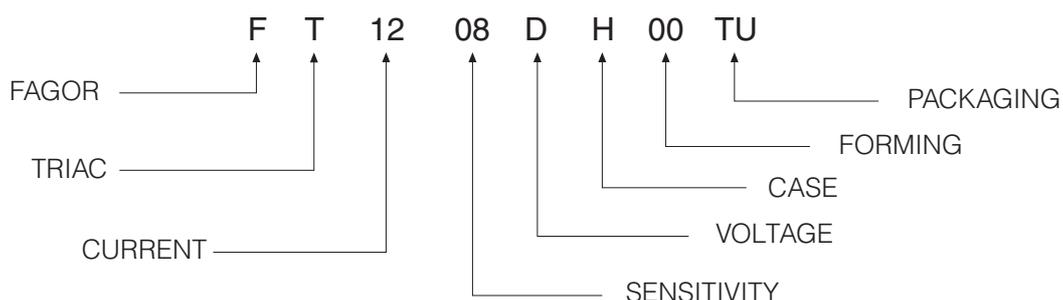
Electrical Characteristics at Tamb = 25 °C

SYMBOL	PARAMETER	CONDITIONS	Quadrant		SENSITIVITY		Unit
					04	08	
$I_{GT}^{(1)}$	Gate Trigger Current	$V_D = 12 V_{DC}, R_L = 33 \Omega, T_j = 25 \text{ }^\circ\text{C}$	Q1÷Q3 Q4	MAX MAX	5	10	mA mA
V_{GT}	Gate Trigger Voltage	$V_D = 12 V_{DC}, R_L = 33 \Omega, T_j = 25 \text{ }^\circ\text{C}$	Q1÷Q3 Q1÷Q4	MAX MAX	1.3		V V
V_{GD}	Gate Non Trigger Voltage	$V_D = V_{DRM}, R_L = 3.3 K\Omega, T_j = 125 \text{ }^\circ\text{C}$	Q1÷Q3 Q1÷Q4	MIN MIN	0.2		V V
$I_H^{(2)}$	Holding Current	$I_T = 100 \text{ mA}, \text{ Gate open}, T_j = 25 \text{ }^\circ\text{C}$		MAX	15		mA
I_L	Latching Current	$I_G = 1.2 I_{GT}, T_j = 25 \text{ }^\circ\text{C}$	Q1,Q3 Q1,Q3,Q4 Q2	MAX MAX MAX	25	30	mA mA mA
$dV/dt^{(2)}$	Critical Rate of Voltage Rise	$V_D = 0.67 \times V_{DRM}, \text{ Gate open}$ $T_j = 125 \text{ }^\circ\text{C}$		MIN	40		V/ μ s
$(dI/dt)_c^{(2)}$	Critical Rate of Current Rise	$(dv/dt)_c = 0.1 \text{ V}/\mu\text{s} \quad T_j = 125 \text{ }^\circ\text{C}$ $(dv/dt)_c = 10 \text{ V}/\mu\text{s} \quad T_j = 125 \text{ }^\circ\text{C}$ without snubber $T_j = 125 \text{ }^\circ\text{C}$		MIN MIN MIN	6.5	2.9	A/ms A/ms
$V_{TM}^{(2)}$	On-state Voltage	$I_T = 17 \text{ Amp}, t_p = 380 \mu\text{s}, T_j = 25 \text{ }^\circ\text{C}$		MAX	1.55		V
$V_{to}^{(2)}$	Threshold Voltage	$T_j = 125 \text{ }^\circ\text{C}$		MAX	0.85		V
$r_d^{(2)}$	Dynamic resistance	$T_j = 125 \text{ }^\circ\text{C}$		MAX	35		m Ω
I_{DRM}/I_{RRM}	Off-State Leakage Current	$V_D = V_{DRM}, T_j = 125 \text{ }^\circ\text{C}$ $V_R = V_{RRM}, T_j = 25 \text{ }^\circ\text{C}$		MAX MAX	1	5	mA μ A
$R_{th(j-c)}$	Thermal Resistance Junction-Case	for AC 360° conduction angle			1.4		$^\circ\text{C}/\text{W}$
$R_{th(j-a)}$	Thermal Resistance Junction-Ambient				60		$^\circ\text{C}/\text{W}$

(1) Minimum I_{GT} is guaranteed at 5% of I_{GT} max.

(2) For either polarity of electrode MT2 voltage with reference to electrode MT1.

Part Number Information

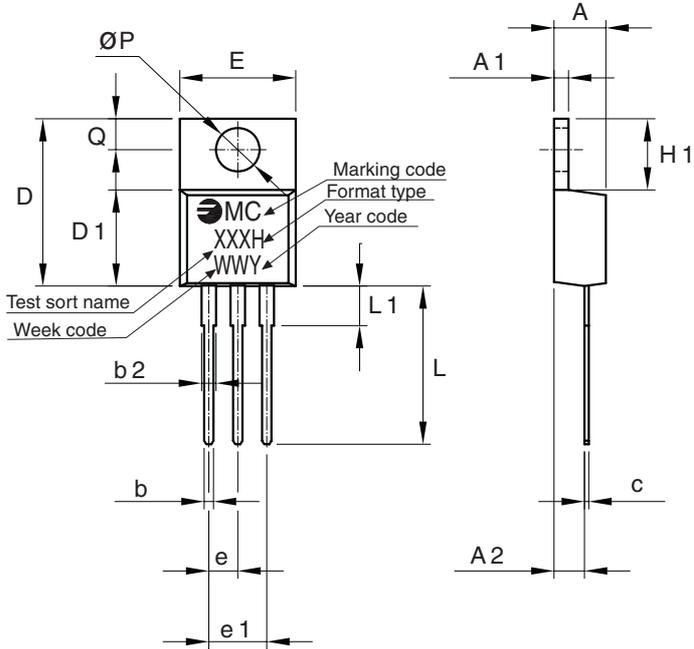


LOGIC LEVEL TRIAC

Ordering information

PREFERRED P/N	PACKAGE CODE	DELIVERY MODE	BASE QUANTITY	UNIT WEIGHT (g)
FT1208MH 00TU	TU	TUBE	1,000	2.30

Package Outline Dimensions: (mm) TO-220AB



The technical drawing shows a TO-220AB package with various dimensions labeled: $\varnothing P$, E, Q, D, D1, L1, L, b2, b, e, e1, A, A1, A2, H1, and c. The marking code is shown as MC, XXXH, and WWY. The marking code is explained as: MC (Marking code), XXXH (Format type), and WWY (Year code). The test sort name and week code are also indicated.

REF.	DIMENSIONS	
	Milimeters	
	Min.	Max.
A	4.47	4.67
A1	1.17	1.37
A2	2.52	2.82
b	0.71	0.91
b2	1.17	1.37
c	0.31	0.53
D	14.65	15.35
D1	8.50	8.90
E	10.01	10.36
e	2.51	2.57
e1	4.98	5.18
H1	6.15	6.45
L	13.40	13.96
L1	3.56	3.96
P	3.735	3.935
Q	2.59	2.89

Mounting Torque	0.8 N.m
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LOGIC LEVEL TRIAC

Ratings and Characteristics (Ta 25 °C unless otherwise noted)

Fig. 1: Maximum power dissipation versus RMS on-state current (full cycle).

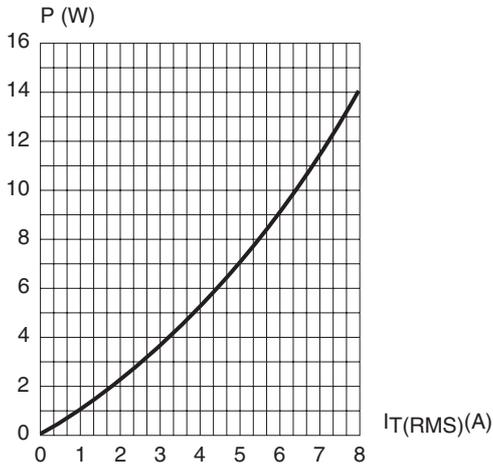


Fig. 2: RMS on-state current versus case temperature (full cycle).

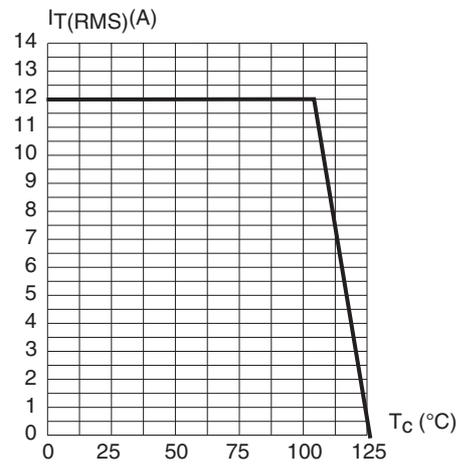


Fig. 3: Relative variation of thermal impedance versus pulse duration.

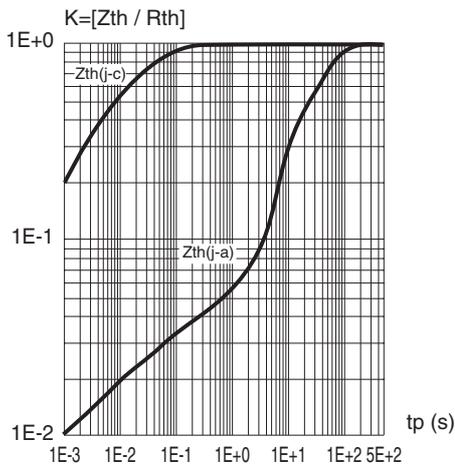


Fig. 4: On-state characteristics (maximum values)

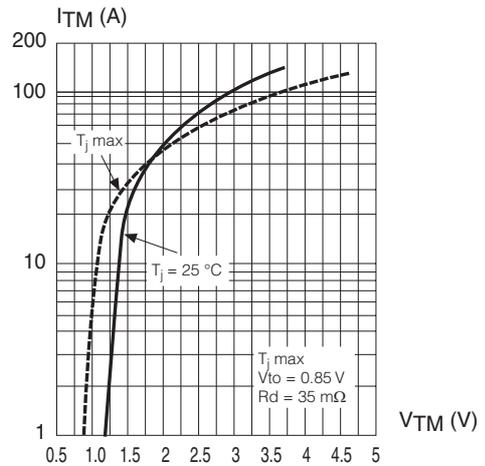


Fig. 5: Surge peak on-state current versus number of cycles

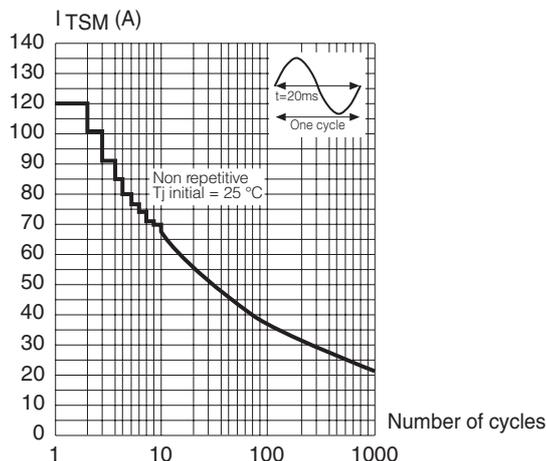
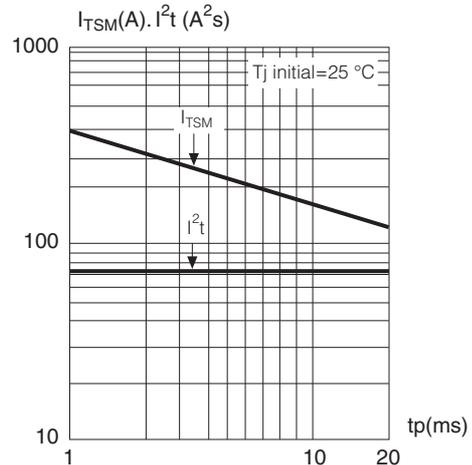


Fig. 6: Non repetitive surge peak on-state current for a sinusoidal pulse with width: tp < 10 ms, and corresponding value of I²t.



LOGIC LEVEL TRIAC

Ratings and Characteristics (Ta 25 °C unless otherwise noted)

Fig. 7: Relative variation of gate trigger current, holding current and latching versus junction temperature (typical values)

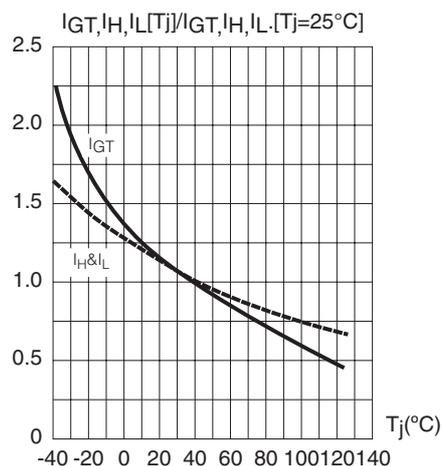


Fig. 8: Relative variation of critical rate of decrease of main current versus junction temperature

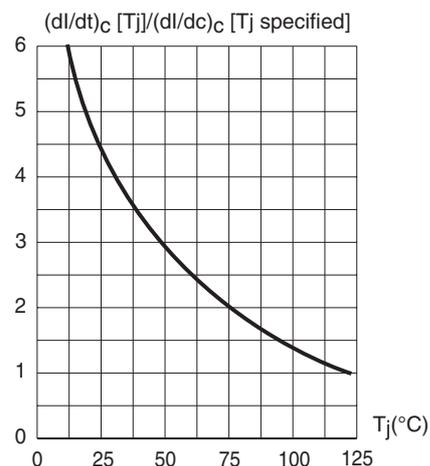
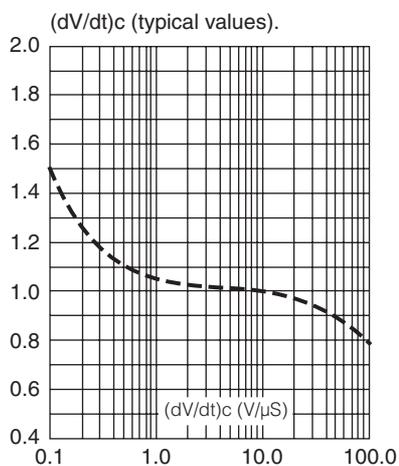


Fig. 9: Relative variation of critical rate of decrease of main current versus



LOGIC LEVEL TRIAC

Revision History

Date	Revision	Description of Changes
14-Jun-2011	0	Original Data Sheet
7-Jun-2013	1	Change values of: $I_{T(RMS)}$ / V_{TM} / $V_{t(o)}$ / $R_{th(j-c)}$

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